

Freeform Search

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 Derwent World Patents Index
 IBM Technical Disclosure Bulletins

Term:

15 and dissipat\$

Display:

10

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Generate:

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Image

Search

Clear

Help

Logout

Interrupt

Main Menu

Show S Numbers

Edit S Numbers

Preferences

Search History

Today's Date: 7/20/2001

<u>DB Name</u>	<u>Query</u>	<u>Hit Count</u>	<u>Set Name</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	15 and dissipat\$	27	<u>L6</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	(bond near (tool or tip or capillary)) and (metal or conduct) and (ceramic or semiconducting or insulating or insulative or insulator or dielectric)	210	<u>L5</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	11 and (bond near (tool or tip or capillary))	0	<u>L4</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	12 and (bond near (tool or tip or capillary))	0	<u>L3</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	11 and (semiconductor or ceramic)	69	<u>L2</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	(electric or electronic) near (dissipate or dissipative)	269	<u>L1</u>

[Help](#)
[Logout](#)
[Interrupt](#)
[Main Menu](#)
[Search Form](#)
[Posting Counts](#)
[Show S Numbers](#)
[Edit S Numbers](#)
[Preferences](#)

Search Results -

Terms	Documents
bond (tool or tip or capillary or foot) and (semiconduct or semiconductor) and (titanium and carbide and nitride)	5

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Refine Search:

bond (tool or tip or capillary or foot)
 and (semiconduct or semiconductor) and
 (titanium and carbide and nitride)

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USPT,PGPB,JPAB,EPAB,DWPI,TDBD	bond (tool or tip or capillary or foot) and (semiconduct or semiconductor) and (titanium and carbide and nitride)	5	<u>L2</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	bond (tool or tip or capillary or foot) and (dissipate or dissipative)	12	<u>L1</u>